TOSHIBA Phototransistor Silicon NPN Epitaxial Planar

TPS611(F)

Lead(Pb)-Free Photoelectric Counter Various Kinds Of Readers Position Detection

• φ5mm epoxy resin package(black)

• High sensitivity: $I_L = 120\mu A(typ.)$

• Half value angle: $\theta 1/2 = \pm 8^{\circ}$ (typ.)

• Protected from external light by black mold packaging.

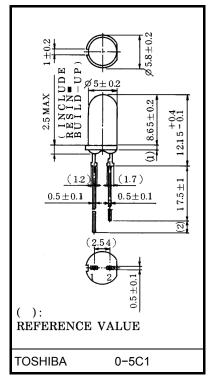
Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-emitter voltage	V _{CEO}	30	V	
Emitter–Collector voltage	V _{ECO}	5	V	
Collector current	IC	50	mA	
Collector power dissipation	PC	150	mW	
Collector power dissipation derating(Ta>25°C)	ΔP _C /°C	-2	mW/°C	
Operating temperature range	T _{opr}	-20~75	°C	
Storage temperature range	T _{stg}	-30~100	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

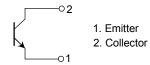
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Unit in mm



Weight: 0.3 g (typ.)

Pin Connection



Opto-electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition		Min	Тур.	Max	Unit
Dark current		I _D (I _{CEO})	I _F = 24V, E=0		_	0.005	0.1	μΑ
Light current		IL	V _{CE} = 3V, E=0.1mW/cm ²	(Note)	30	120		μΑ
Collector–emitter saturation voltage		V _{CE} (sat)	I _C = 15μA, E=0.1mW/cm ²	(Note)	_	0.25	0.4	V
Switching time	Rise time	t _r	V_{CC} = 5V, I_C = 2mA R_L = 100 Ω		_	6	_	
	Fall time	t _f			_	6	_	μs
Peak sensitivity wavelength		λ _P				900	_	nm
Half value angle		$\theta \frac{1}{2}$	_		_	±8	_	0

Note: Color temperature = 2870K, standard tungsten lamp

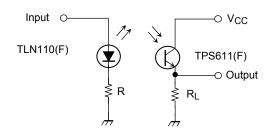
Precaution

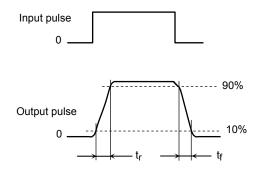
Please be careful of the followings.

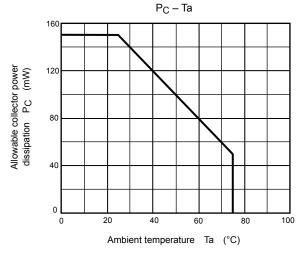
- 1. Soldering temperature: 260°C max. Soldering time: 5s max. (Soldering portion of lead: The top portion from the lead stopper.)
- 2. When the leads is formed, the lead shall be formed at the top portion of the stopper without leaving forming stress to the body of the device. Soldering shall be performed after lead forming.

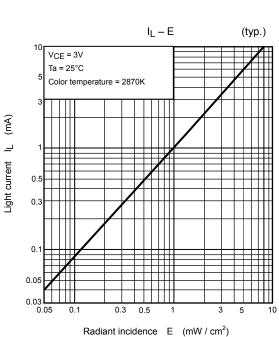
2 2007-10-01

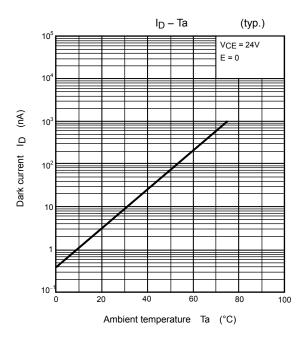
Fig.1 Switching time test circuit

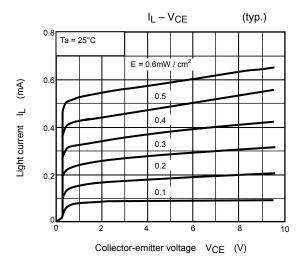




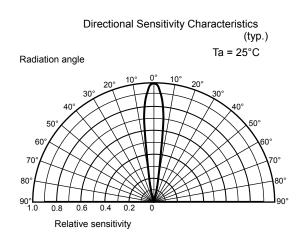


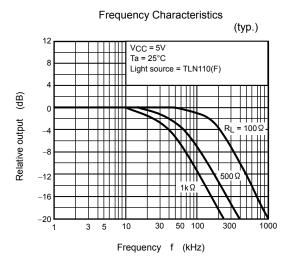


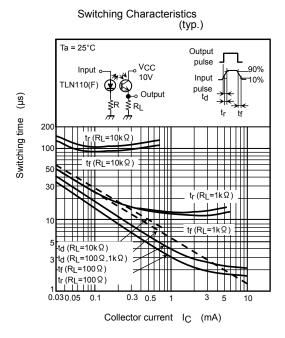


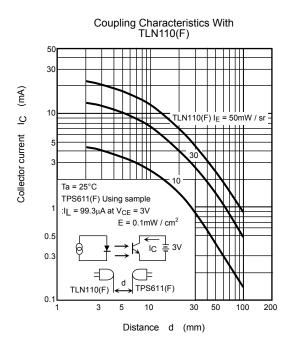


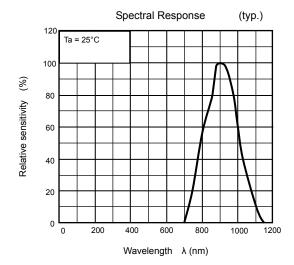
3











5 2007-10-01

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No
 responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which
 may result from its use. No license is granted by implication or otherwise under any patents or other rights of
 TOSHIBA or the third parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS
 compatibility. Please use these products in this document in compliance with all applicable laws and regulations
 that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses
 occurring as a result of noncompliance with applicable laws and regulations.